



US 20220354026A1

(19) **United States**(12) **Patent Application Publication**
KELLEY et al.(10) **Pub. No.: US 2022/0354026 A1**(43) **Pub. Date: Nov. 3, 2022**(54) **COMPUTER COOLING****Publication Classification**(71) Applicant: **Microsoft Technology Licensing, LLC**,
Redmond, WA (US)(51) **Int. Cl.**
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CPC **H05K 7/20809** (2013.01); **H05K 7/20818**
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Redmond, WA (US)(21) Appl. No.: **17/361,064**(22) Filed: **Jun. 28, 2021****Related U.S. Application Data**(60) Provisional application No. 63/183,259, filed on May
3, 2021.(57) **ABSTRACT**

The description relates to cooling electronic components, such as computing devices. One example includes a rack defining a volume and multiple sealed chassis modules removably fluidly coupled to a two-phase condenser tank via a vapor coupler and a liquid coupler. Individual sealed chassis modules can contain one or more electronic components immersed in two-phase coolant that when heated by operation of the electronic components experiences a phase change from a liquid phase to a gas phase and travels to the two-phase condenser tank via the vapor coupler and is cooled in the two-phase condenser tank until experiencing a phase change back into the liquid phase. Individual sealed chassis modules can be decoupled from the two-phase condenser tank without releasing two-phase coolant and an entirety of the multiple sealed chassis modules and the condenser tank are contained in the volume of the rack.

DATACENTER RACK SYSTEM 100